TAPE Attachment Method

Part Number: 374724B00032G





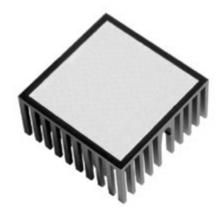
This part is in stock and available for immediate delivery

Contact your local sales rep

BGA Surface	Tape Type	Heat Sink Finish
Metal	<u>T405R</u>	Black Anodize

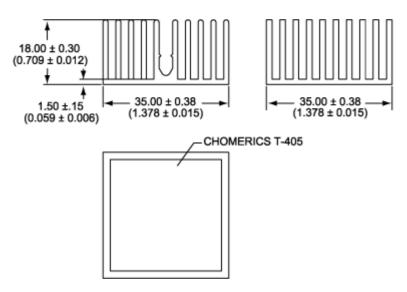
Features and Benefits

- Configurations are available for a wide range of BGA package sizes
- Tape mounted versions eliminate the need for mounting holes in the PC Board
- These Heat Sinks can be used with either plastic or metal/ceramic BGA Packages depending on tape used
- These Heat Sinks are compatible with Ther-a-grip tapes



Width	Length			Fin Thickness Across Length	Base Thickness	# of fins across width	# of fins across length
35mm	35mm	18mm	1.40mm	1.57mm	1.50mm	10	10

Mechanical Outline Drawing

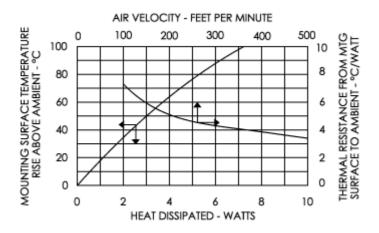


Unless otherwise shown, tolerances are $\pm 0.38(\pm .015)$

Thermal Performance

*θn	**0f		
15.3	5.15		

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- *Natural convection thermal resistance is based on a 75 °C heat sink temperature rise.
- **Forced convection thermal resistance based on an entering 1.0 m/s (200 lfm) airflow. Due to various heat dissipation paths within a BGA device, please test the heat sink in your application.

This data sheet represents only one of a broad range of products we make to cool electronics. Our representatives can help you configure a complete cooling solution for your individual applications.

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